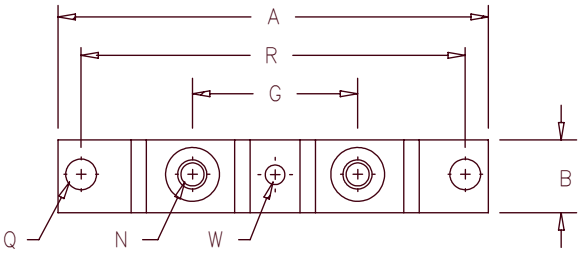
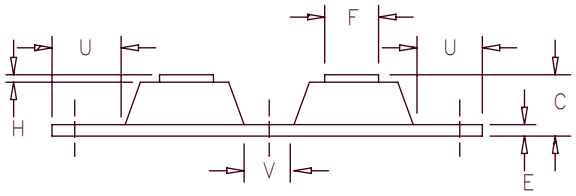
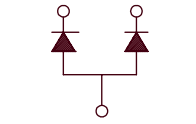
Schottky PowerMod

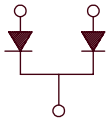
CPT50235 – CPT50245







Baseplate
A=Common Anode



Baseplate
Common Cathode

Baseplate
D=Doubler

Notes:
Baseplate: Nickel plated copper

Dim.	Inches		Millimeters		
	Min.	Max.	Min.	Max.	Notes
A	---	3.630	---	92.20	
B	0.700	0.800	17.78	20.32	
C	0.615	0.640	15.53	16.26	
E	0.120	0.130	3.05	3.30	
F	0.490	0.510	12.45	12.95	
G	1.375 BSC		34.92 BSC		
H	0.007	0.030	0.18	0.76	
N	---	---	---	---	1/4-20
Q	0.275	0.290	6.99	7.37	Dia.
R	3.150 BSC		80.01 BSC		
U	0.600	---	15.24	---	
V	0.312	0.340	7.92	8.64	
W	0.180	0.195	4.57	4.95	Dia.

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
CPT50235*	440CNQ030 444CNQ035 MBR50035CT	35V	35V
CPT50240*	444CNQ040 MBR50040CT	40V	40V
CPT50245*	444CNQ045 MBR50045CT	45V	45V

*Add Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- 500 Amperes/35 to 45 Volts
- 150°C Junction Temperature
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$	500 Amps	T_C = 79°C, square wave, $R_{\theta JC}$ = 0.12°C/W
Average forward current per leg	$I_{F(AV)}$	250 Amps	T_C = 79°C, square wave, $R_{\theta JC}$ = 0.24°C/W
Maximum surge current per leg	I_{FSM}	5000 Amps	8.3ms, half sine, T_J = 150°C
Maximum repetitive reverse current per leg	$I_{R(OV)}$	2 Amps	f = 1 KHZ, 25°C, 1μsec square wave
Max peak forward voltage per leg	V_{FM}	0.55 Volts	I_{FM} = 250A; T_J = 25°C*
Max peak forward voltage per leg	V_{FM}	0.49 Volts	I_{FM} = 250A; T_J = 150°C*
Max peak reverse current per leg	I_{RM}	4.0 A	V_{RRM}, T_J = 125°C*
Max peak reverse current per leg	I_{RM}	12.0 mA	V_{RRM}, T_J = 25°C*
Typical junction capacitance per leg	C_J	10500 pF	V_R = 5.0V, T_C = 25°C

*Pulse test: Pulse width 300μsec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range	T_{STG}	−55°C to 150°C
Operating junction temp range	T_J	−55°C to 150°C
Max thermal resistance per leg	$R_{\theta JC}$	0.24°C/W Junction to case
Max thermal resistance per pkg	$R_{\theta JC}$	0.12°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.08°C/W Case to sink
Terminal Torque		35–40 inch pounds
Mounting Base Torque (outside holes)		30–40 inch pounds
Mounting Base Torque (center hole)		8–10 inch pounds
center hole must be torqued first		
Weight		2.8 ounces (78 grams) typical

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Figure 1
Typical Forward Characteristics – Per Leg

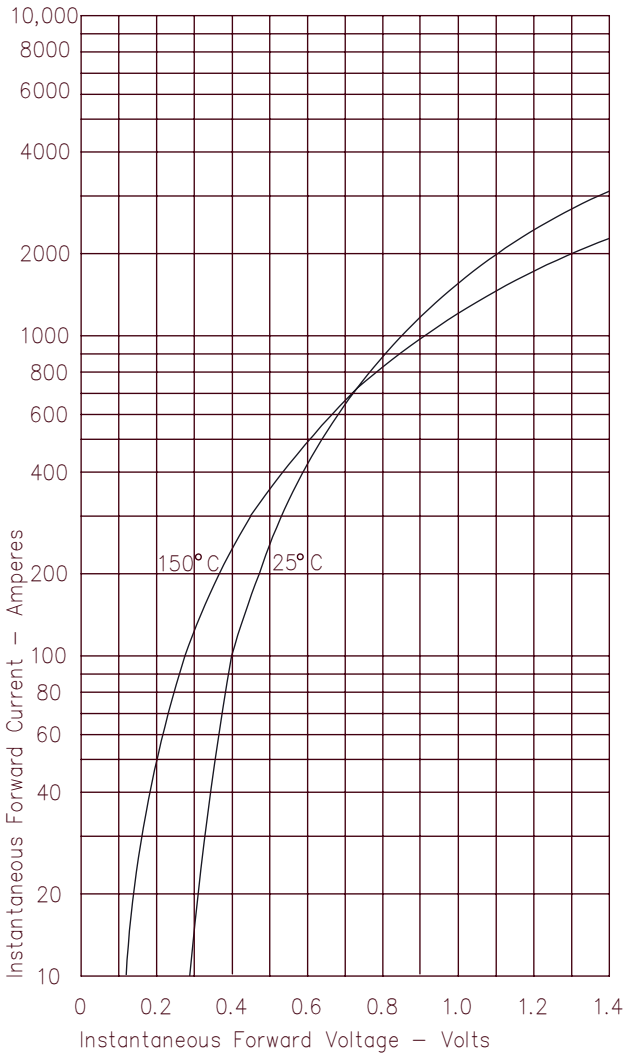


Figure 2
Typical Reverse Characteristics – Per Leg

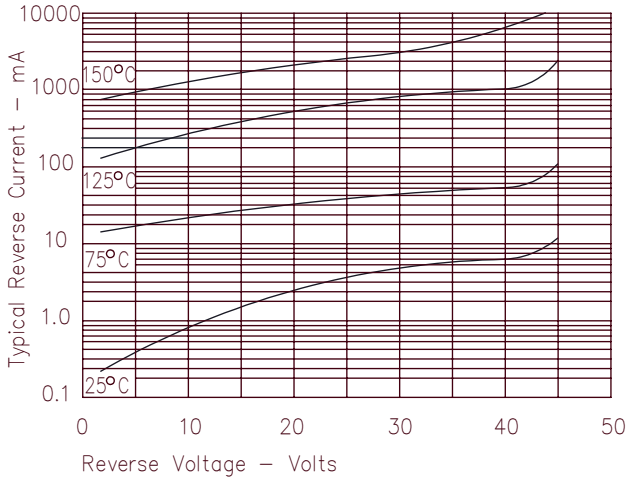


Figure 3
Typical Junction Capacitance – Per Leg

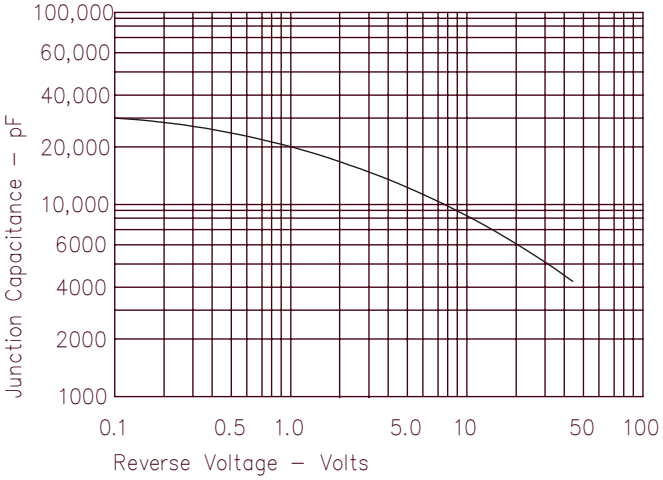


Figure 4
Forward Current Derating – Per Leg

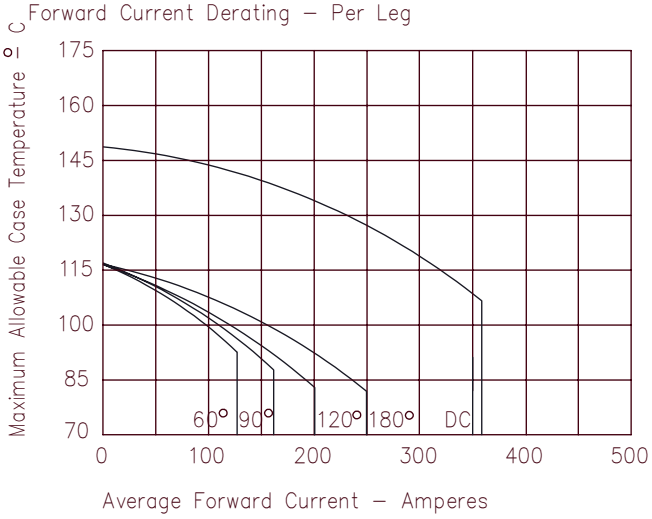
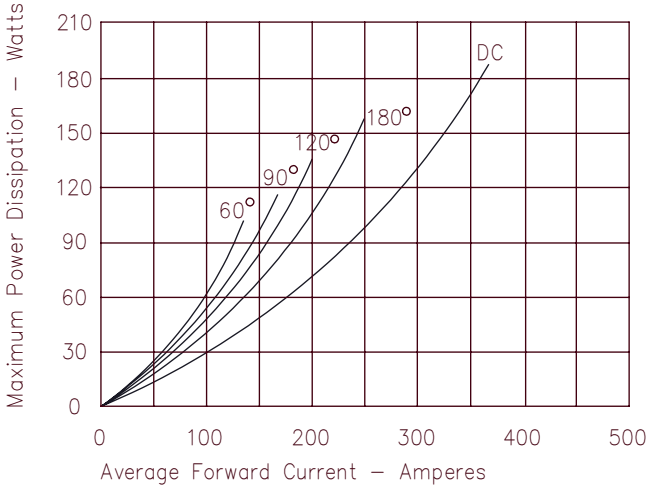


Figure 5
Maximum Forward Power Dissipation – Per Leg



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